

|           |     |   |
|-----------|-----|---|
| $V_R$     | 30  | V |
| $I_o$     | 40  | A |
| $I_{FSM}$ | 100 | A |

#### ● Features

- High reliability
- Power mold type
- Cathode common dual type
- Super Low  $I_R$

#### ● Application

- Switching power supply

#### ● Structure

- Silicon epitaxial planar

#### ● Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ unless otherwise specified)

| Parameter                         | Symbol    | Conditions   | Limits    | Unit             |
|-----------------------------------|-----------|--|-----------|------------------|
| Repetitive peak reverse voltage   | $V_{RM}$  | Duty $\leq 0.5$  | 35        | V                |
| Reverse voltage                   | $V_R$     | Reverse direct voltage   | 30        | V                |
| Average rectified forward current | $I_o$     | 60Hz half sin waveform, resistive load, $I_o/2$ per diode, $T_c=90^\circ\text{C Max.}$ | 40        | A                |
| Peak forward surge current        | $I_{FSM}$ | 60Hz half sin waveform, non-repetitive, per diode, $T_a=25^\circ\text{C}$              | 100       | A                |
| Junction temperature              | $T_j$     | -  | 150       | $^\circ\text{C}$ |
| Storage temperature               | $T_{stg}$ | -  | -55 ~ 150 | $^\circ\text{C}$ |

#### Attention

Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current ( $I_R$ ). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further  $I_R$ . This phenomenon might end up the thermal destruction (thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

#### ● Outline



#### ● Inner Circuit



#### ● Packaging Specifications

| Packing          | Embossed Tape |
|------------------|---------------|
| Reel Size(mm)    | 330           |
| Taping Width(mm) | 24            |
| Quantity(pcs)    | 1000          |
| Taping Code      | TL            |
| Marking          | RB238NS30     |

● Electrical Characteristics (T<sub>j</sub>=25°C unless otherwise specified)

| Parameter                      | Symbol         | Conditions          | Min. | Typ. | Max. | Unit |
|--------------------------------|----------------|---------------------|------|------|------|------|
| Forward voltage <sup>(1)</sup> | V <sub>F</sub> | I <sub>F</sub> =20A | -    | -    | 0.75 | V    |
| Reverse current <sup>(1)</sup> | I <sub>R</sub> | V <sub>R</sub> =30V | -    | -    | 12   | μA   |

Note (1) Value per diode

● Thermal Characteristics

| Parameter   | Symbol           | Min. | Typ. | Max. | Unit |
|---|------------------|------|------|------|------|
| Thermal Resistance (Junction to case) <sup>(1) (2)</sup>    | Per diode        | -    | -    | 0.86 | °C/W |
|   | Per device       | -    | -    | 0.50 | °C/W |
| Thermal Resistance (Junction to ambient) <sup>(1) (3)</sup> | R <sub>θJA</sub> | -    | -    | 55   | °C/W |

Notes (1) Value is guaranteed by design.

(2) Transient dual interface measurement (TDIM) method.

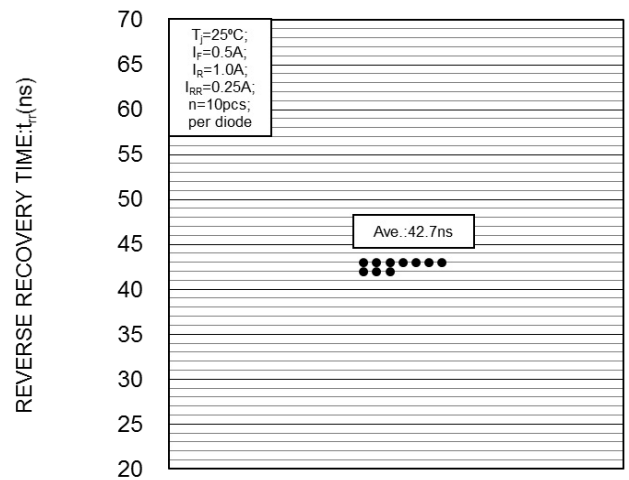
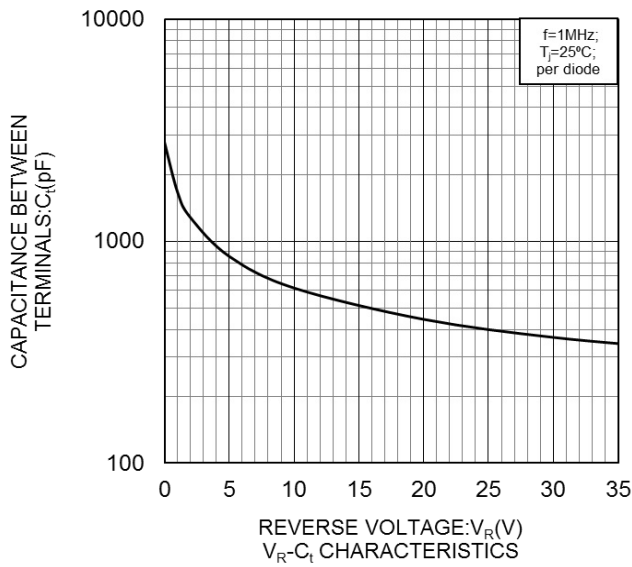
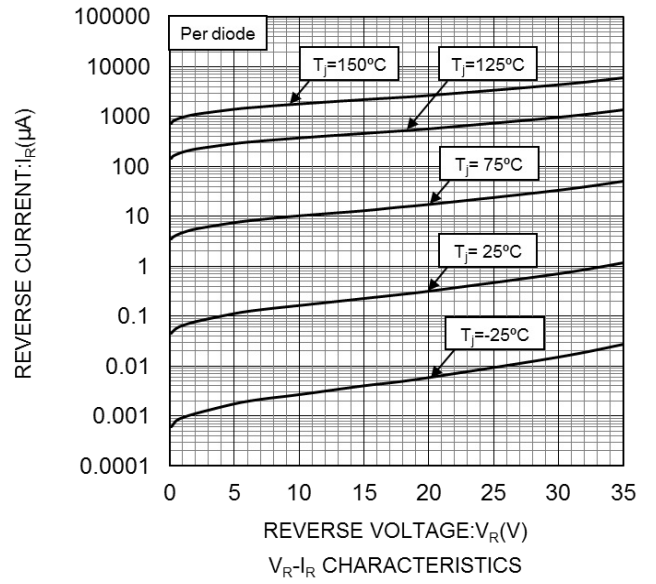
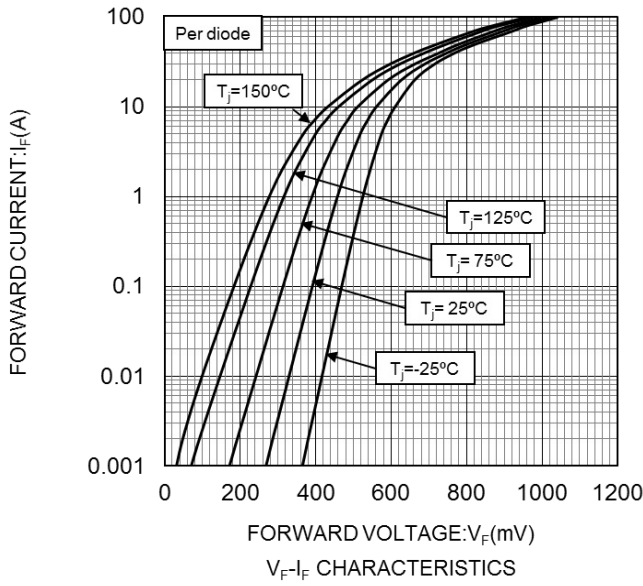
(3) Mounted on 50 x 50 x 1.6mm FR4 board, single-sided copper, 35μm thickness, reference footprint.

● Characteristic Curves

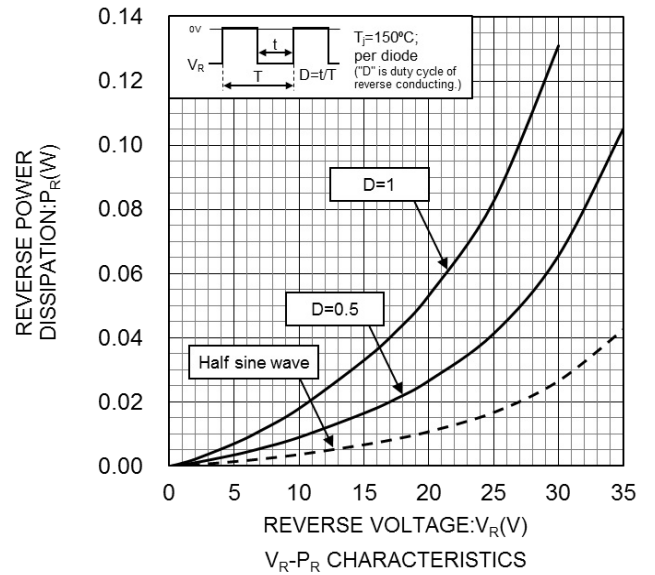
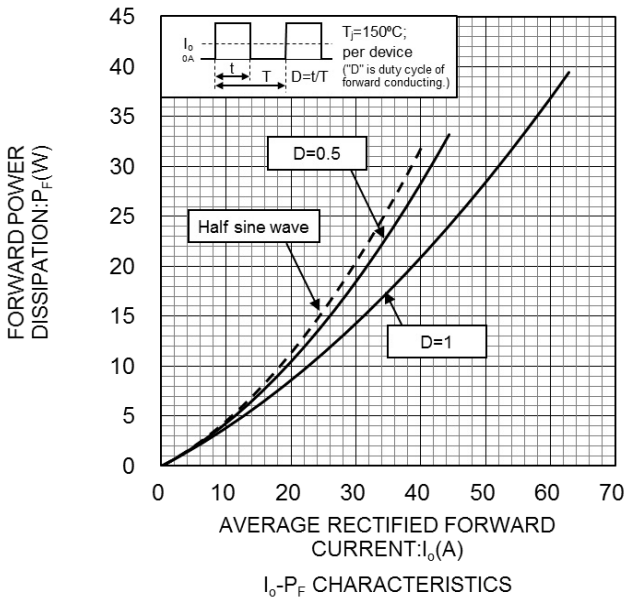
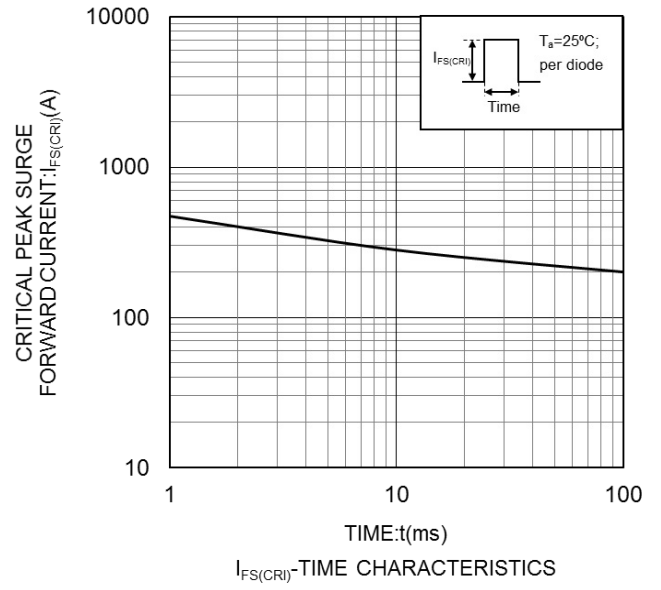
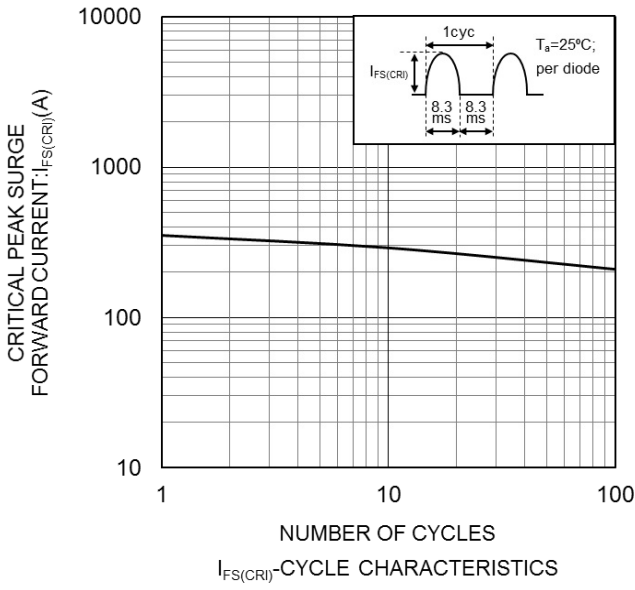


NORMALIZED TRANSIENT THERMAL IMPEDANCE FROM JUNCTION TO CASE (PER DEVICE)

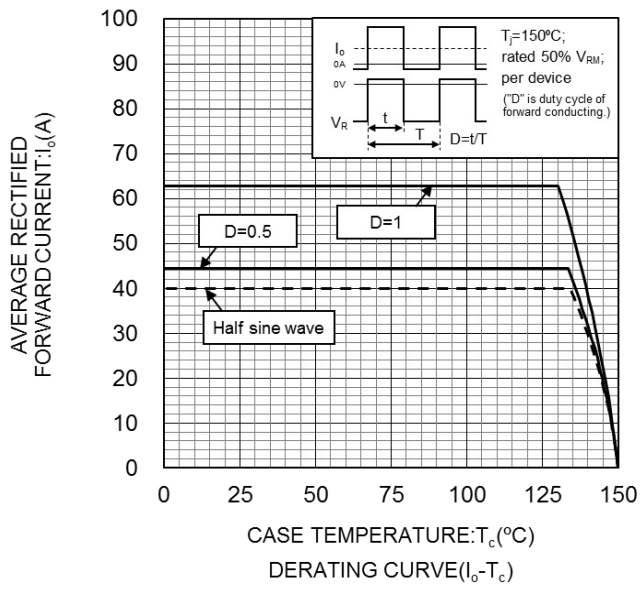
● Characteristic Curves



● Characteristic Curves



● Characteristic Curves



● Dimensions

TO-263S, [SC-83], (TO-263S)



| DIM | Millimeters |         |       | Inches |         |       |
|-----|-------------|---------|-------|--------|---------|-------|
|     | Min.        | Average | Max.  | Min.   | Average | Max.  |
| A   | 4.30        | 4.50    | 4.70  | 0.169  | 0.177   | 0.185 |
| A1  | 0.00        | -       | 0.30  | 0.000  | -       | 0.012 |
| A2  | 2.50        | 2.70    | 2.90  | 0.098  | 0.106   | 0.114 |
| b   | 0.75        | 0.76    | 0.78  | 0.030  | 0.030   | 0.031 |
| b2  | 1.21        | 1.22    | 1.24  | 0.048  | 0.048   | 0.049 |
| b6  | -           | 1.30    | -     | -      | 0.051   | -     |
| c   | 0.52        | 0.62    | 0.82  | 0.020  | 0.024   | 0.032 |
| c2  | 1.10        | 1.30    | 1.50  | 0.043  | 0.051   | 0.059 |
| D   | 8.80        | 9.00    | 9.20  | 0.346  | 0.354   | 0.362 |
| D1  | -           | 7.25    | -     | -      | 0.285   | -     |
| E   | 9.80        | 10.10   | 10.40 | 0.386  | 0.398   | 0.409 |
| E1  | -           | 8.90    | -     | -      | 0.350   | -     |
| e   | -           | 2.54    | -     | -      | 0.100   | -     |
| H   | 12.80       | 13.10   | 13.40 | 0.504  | 0.516   | 0.528 |
| L   | -           | 1.20    | -     | -      | 0.047   | -     |
| L1  | -           | 1.10    | -     | -      | 0.043   | -     |
| L2  | 0.70        | 1.00    | 1.30  | 0.028  | 0.039   | 0.051 |
| L3  | 2.70        | 3.00    | 3.30  | 0.106  | 0.118   | 0.130 |

| DIM | Millimeters |         |      | Inches |         |      |
|-----|-------------|---------|------|--------|---------|------|
|     | Min.        | Average | Max. | Min.   | Average | Max. |
| b3  | -           | 2.50    | -    | -      | 0.098   | -    |
| b4  | -           | 9.90    | -    | -      | 0.390   | -    |
| b5  | -           | 11.00   | -    | -      | 0.433   | -    |
| l1  | -           | 2.50    | -    | -      | 0.098   | -    |
| l2  | -           | 8.50    | -    | -      | 0.335   | -    |
| l3  | -           | 14.00   | -    | -      | 0.551   | -    |
| l4  | -           | 2.50    | -    | -      | 0.098   | -    |

● Taping (Unit:mm)



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| JAPAN     | USA       | EU         | CHINA     |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV  |           | CLASS III  |           |

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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  - [h] Use of the Products in places subject to dew condensation
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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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